E ⬡3

-B-

L2 ⬡3

D

1   3

L1

b2

e

2 PL

b

⊕ | .25 Ⓜ | A | B Ⓜ

2 PL

-A-

A

A1

c2
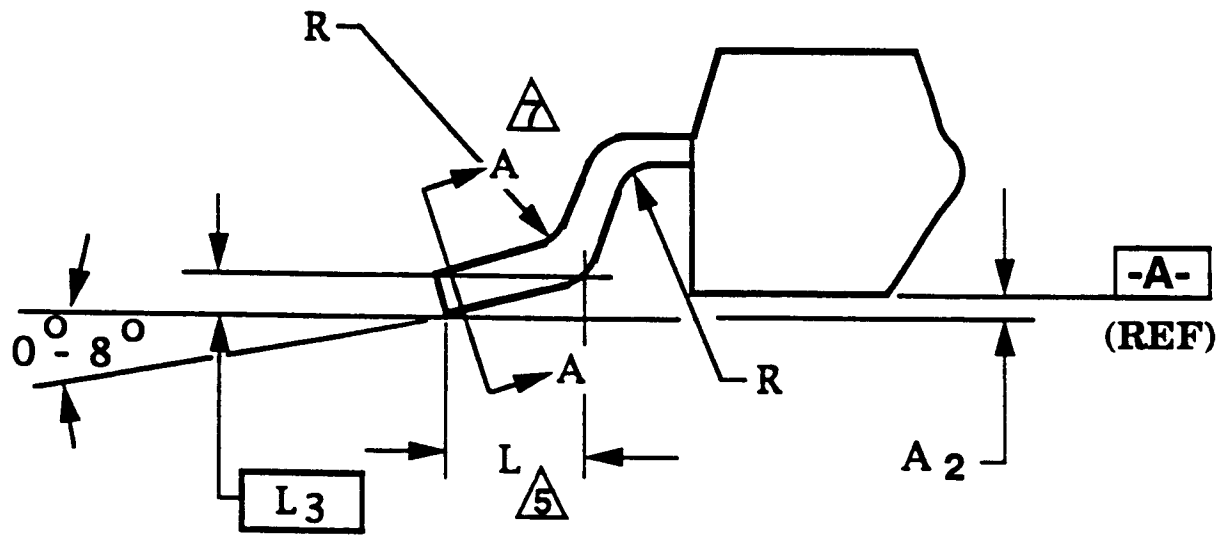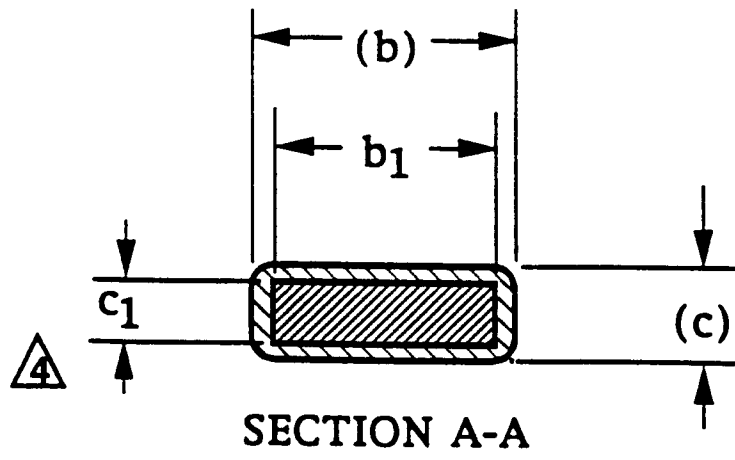
B

H

B

c

DETAIL "A"

E1

2 PL

⬡6

D1

• TERM. 4

BACK VIEW B - B

THIS REGISTERED OUTLINE HAS BEEN PREPARED BY THE JEDEC JC-11 COMMITTEE AND REFLECTS A PRODUCT WITH ANTICIPATED USAGE IN THE ELECTRONICS INDUSTRY, CHANGES ARE LIKELY TO OCCUR.

(b)

b_1

c_1

⚠4

(c)

SECTION A-A

R

⚠7

A

R

0° - 8°

A

-A-

(REF)

L_3

L

⚠5

A_2

DETAIL "A" ROTATED 90°

NOTES:

1. REFER TO APPLICABLE SYMBOL LIST.

2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1982.

$\triangle$3 TAB CONTOUR OPTIONAL WITHIN DIMENSION E & L_2.

$\triangle$4 DIMENSIONS b_1 AND c_1 APPLY TO BASE METAL ONLY. DIMENSIONS b & c APPLY TO PLATED LEADS.

$\triangle$5 L IS THE TERMINAL LENGTH FOR SOLDERING.

$\triangle$6 D_1 & E_1 ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERM 4.

$\triangle$7 SECTION A-A DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .13 TO .25 MILLIMETERS FROM THE LEAD TIP.

8. DIMENSION "D" DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .13 MILLIMETERS PER SIDE.

9. ALL DIMENSIONS IN MILLIMETER.

| SYMBOL | VARIATIONS | | | |
| | AA | | | |
	MIN	NOM	MAX	NOTES
A	4.90	5.00	5.10	
A_1	2.70	2.80	2.90	
A_2	.02	.10	.25	
b	1.15	-	1.45	4,7
b_1	1.15	1.25	1.40	4,7
b_2	1.90	2.00	2.10	
c	.40	-	.65	4,7
c_1	.40	.50	.60	4,7
c_2	1.45	1.50	1.60	
D	13.80	13.90	14.00	8
D_1	12.40	12.55	12.70	6
E	15.85	15.95	16.05	
E_1	13.30	13.45	13.60	6
e		5.45 BSC		
H	18.70	18.90	19.10	
L	2.40	2.55	2.70	5
L_1	1.20	1.30	1.40	
L_2	1.00	1.10	1.15	3
L_3		.25 BSC		
R	1.00	1.50	2.00	

NOTE	1, 2, 9
REF.	10-352
ISSUE	

| JEDEC SOLID STATE PRODUCT OUTLINES | TITLE: R-PSFM-G2 HEADER FAMILY SURFACE MOUNTED (PERIPHERAL TERMINALS) | ISSUE A | DATE 6-95 | TO-268 | SHEET 3 OF 3 |